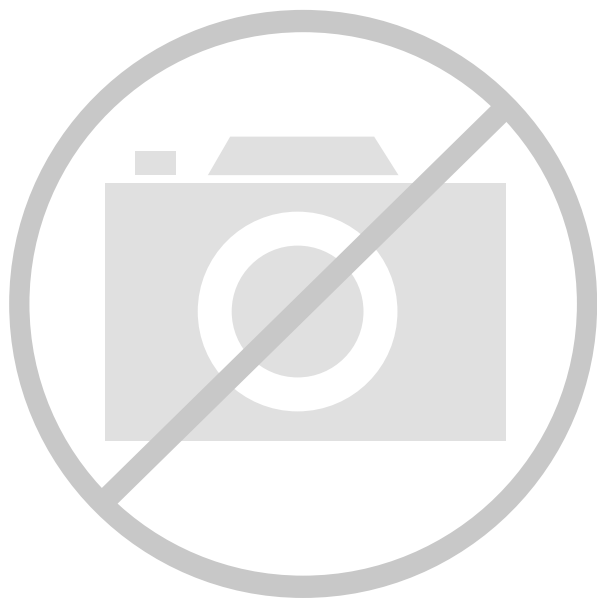




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

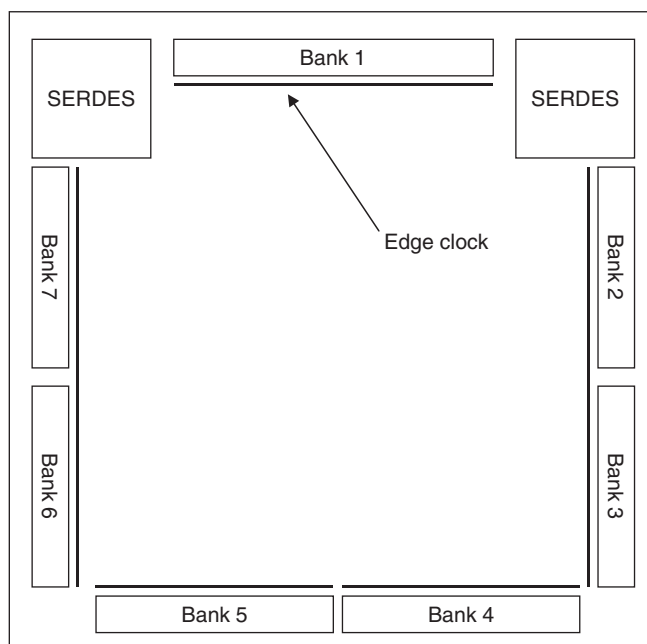
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

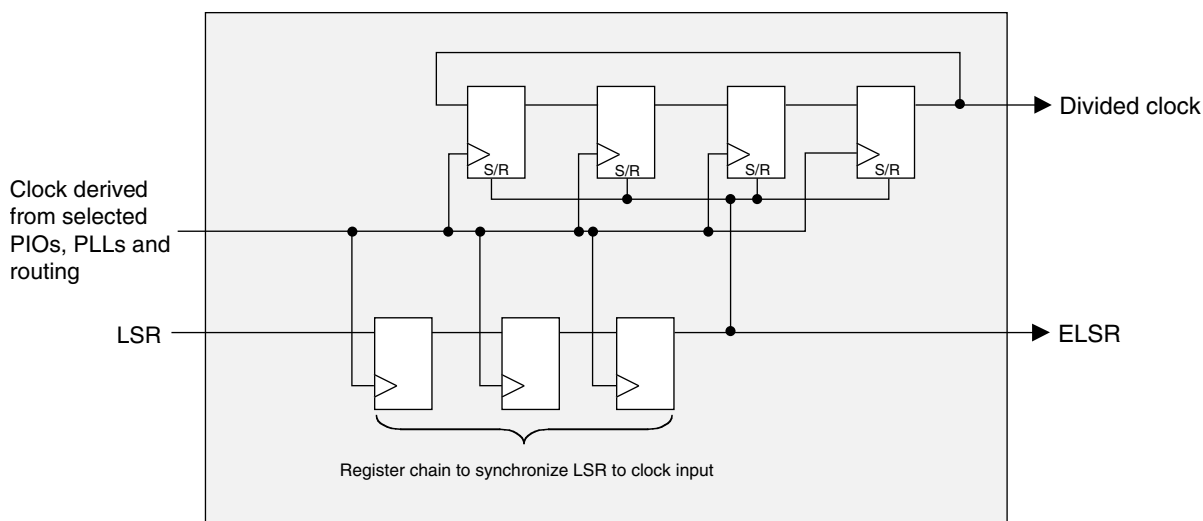
Details

Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga115ep1-5ffn1152c

Figure 2-7. Edge Clock Resources

Precision Clock Divider

Each set of edge clocks has four high-speed dividers associated with it. These are intended for generating a slower speed system clock from the high-speed edge clock. The block operates in a DIV2 or DIV4 mode and maintains a known phase relationship between the divided down clock and high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PIOs, PLLs and routing. The clock divider outputs serve as primary clock sources. This circuit also generates an edge local set/reset (ELSR) signal which is fed to the PIOs via the edge clock network and is used for the rest of the I/O gearing logic.

Figure 2-8. Clock Divider Circuit

Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved irrespective of where the select signal is

toggled. There are eight DCS blocks per device, located in pairs at the center of each side. Figure 2-9 illustrates the DCS Block diagram.

Figure 2-9. DCS Block Diagram

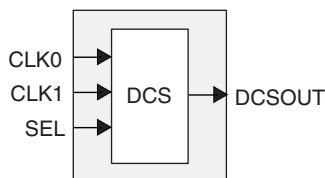
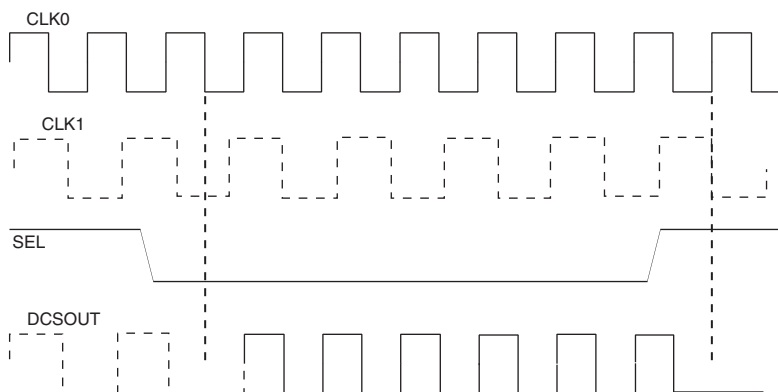


Figure 2-10 shows timing waveforms for one of the DCS operating modes. The DCS block can be programmed to other modes. For more information on the DCS, please see details of additional technical documentation at the end of this data sheet.

Figure 2-10. DCS Waveforms



Clock Boosting

There are programmable delays available in the clock signal paths in the PFU, PIC and EBR blocks. These allow setup and clock-to-output times to be traded to meet critical timing without slowing the system clock. If this feature is enabled then the design tool automatically uses these delays to improve timing performance.

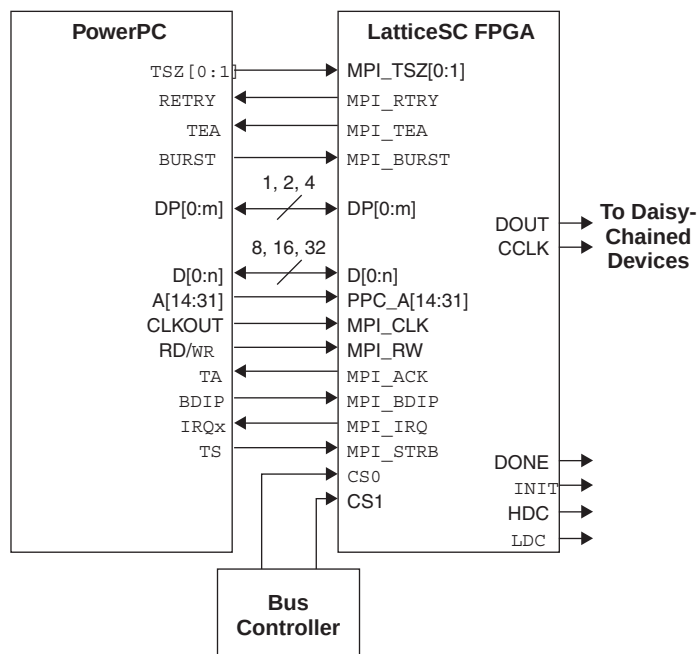
Global Set/Reset

There is a global set/reset (GSR) network on the device that is distributed to all FFs, PLLs, DLLs and other blocks on the device. This GSR network can operate in two modes:

- asynchronous - no clock is required to get into or out of the reset state.
- synchronous - The global GSR net is synchronized to a user selected clock. In this mode it continues to be asynchronous to get into the reset state, but is synchronous to get out of the reset state. This allows all registers on the device to become operational in the same clock period. The synchronous GSR goes out of reset in two cycles from the clock edge where the setup time of the FF was met (not from the GSR being released).

sysCLOCK Phase Locked Loops (PLLs)

The sysCLOCK PLLs provide the ability to synthesize clock frequencies. Each PLL has four dividers associated with it: input clock divider, feedback divider and two clock output dividers. The input divider is used to divide the input clock signal, while the feedback divider is used to multiply the input clock signal.

Figure 2-32. PowerPCI and MPI Schematic

Configuration and Testing

The following section describes the configuration and testing features of the LatticeSC family of devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeSC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS33, 25 and 18 standards. For additional detail refer to technical information at the end of the data sheet.

Device Configuration

All LatticeSC devices contain three possible ports that can be used for device configuration. The serial port, which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration. The MPI port supports 8-bit, 16-bit or 32-bit configuration.

The serial port supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins. When sysCONFIG mode is not used, these dual-use pins are available for general purpose I/O. All I/Os for the sysCONFIG and MPI ports are in I/O bank #1.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next re-initialization sequence. For additional detail refer to technical information at the end of the data sheet.

Density Shifting

The LatticeSC family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

PURESPEED I/O Single-Ended DC Electrical Characteristics

Over Recommended Operating Conditions

Input/Output Standard	V _{IL}		V _{IH}		V _{OL} Max. (V)	V _{OH} Min. (V)	I _{OL} (mA)	I _{OH} (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVC MOS 33	-0.3	0.8	2	3.465	0.4	2.4	24, 16, 8	-24, -16, -8
					0.2	VCCIO - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2	3.465	0.4	2.4	24, 16, 8	-24, -16, -8
					0.2	VCCIO - 0.2	0.1	-0.1
LVC MOS 25	-0.3	0.7	1.7	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVC MOS 18	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVC MOS 15	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVC MOS 12	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.3	VCCIO - 0.3	12, 8, 4, 2	-12, -8, -4, -2
					0.2	VCCIO - 0.2	0.1	-0.1
PCIX15	-0.3	0.3VCCIO	0.5VCCIO	1.5	0.1VCCIO	0.9VCCIO	1.5	-0.5
PCI33	-0.3	0.3VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
PCIX33	-0.3	0.35VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
AGP-1X, AGP-2X	-0.3	0.3VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
SSTL3_I	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.7	VCCIO - 1.1	8	-8
SSTS3_I OST ²	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.9	VCCIO - 1.3	8	-8
SSTL3_II	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.5	VCCIO - 0.9	16	-16
SSTL3_II OST ²	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.9	VCCIO - 0.13	16	-16
SSTL2_I	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.54	VCCIO - 0.62	7.6	-7.6
SSTL2_I OST ²	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.73	VCCIO - 0.81	7.6	-7.6
SSTL2_II	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.35	VCCIO - 0.43	15.2	-15.2
SSTL2_II OST ²	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.73	VCCIO - 0.81	15.2	-15.2
SSTL18_I	-0.3	VREF - 0.125	VREF + 0.125	2.65	0.28	VCCIO - 0.28	13.4	-13.4
SSTL18_II	-0.3	VREF - 0.125	VREF + 0.125	2.65	0.28	VCCIO - 0.28	13.4	-13.4
HSTL15_I	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	8	-8
HSTL15_II	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	16	-16
HSTL15_III ¹	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL15_IV ¹	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL18_I	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	9.6	-9.6
HSTL18_II	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	19.2	-19.2
HSTL18_III ¹	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL18_IV ¹	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
GTL12 ¹ , GTLPLUS15 ¹	-0.3	VREF - 0.2	VREF + 0.2	N/A	N/A	N/A	N/A	N/A

1. Input only.

2. Input with on-chip series termination.

Switching Characteristics

All devices are 100% functionally tested. Listed below are representative values of internal and external timing parameters. For more specific, more precise, and worst-case guaranteed data at a particular temperature and voltage, use the values reported by the static timing analyzer in the ispLEVER design tool from Lattice and back-annotate to the simulation net list.

LatticeSC/M Family Timing Adders

Over Recommended Operating Conditions at VCC = 1.2V +/- 5%

Buffer Type	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Input Adjusters								
LVDS	LVDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
RSDS	RSDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
BLVDS25	BLVDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
MLVDS25	MLVDS	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
LVPECL33	LVPECL	-0.031	-0.031	-0.011	-0.011	0.009	0.009	ns
HSTL18_I	HSTL_18 class I	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL18_II	HSTL_18 class II	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL18_III	HSTL_18 class III	-0.016	-0.018	0.008	0.003	0.032	0.023	ns
HSTL18_IV	HSTL_18 class IV	-0.016	-0.018	0.008	0.003	0.032	0.023	ns
HSTL18D_I	Differential HSTL 18 class I	0.006	0.001	0.029	0.024	0.052	0.046	ns
HSTL18D_II	Differential HSTL 18 class II	0.006	0.001	0.029	0.024	0.052	0.046	ns
HSTL15_I	HSTL_15 class I	-0.005	-0.016	0.026	-0.001	0.057	0.014	ns
HSTL15_II	HSTL_15 class II	-0.005	-0.016	0.026	-0.001	0.057	0.014	ns
HSTL15_III	HSTL_15 class III	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL15_IV	HSTL_15 class IV	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
HSTL15D_I	Differential HSTL 15 class I	-0.021	-0.022	0.001	-0.009	0.022	0.003	ns
HSTL15D_II	Differential HSTL 15 class II	-0.021	-0.022	0.001	-0.009	0.022	0.003	ns
SSTL33_I	SSTL_3 class I	-0.036	-0.061	-0.181	-0.313	-0.326	-0.565	ns
SSTL33_II	SSTL_3 class II	-0.036	-0.061	-0.181	-0.313	-0.326	-0.565	ns
SSTL33D_I	Differential SSTL_3 class I	0.012	0.012	0.034	0.028	0.055	0.043	ns
SSTL33D_II	Differential SSTL_3 class II	0.012	0.012	0.034	0.028	0.055	0.043	ns
SSTL25_I	SSTL_2 class I	0.003	-0.008	0.03	0.011	0.058	0.03	ns
SSTL25_II	SSTL_2 class II	0.003	-0.008	0.03	0.011	0.058	0.03	ns
SSTL25D_I	Differential SSTL_2 class I	0.006	0	0.031	0.023	0.056	0.046	ns
SSTL25D_II	Differential SSTL_2 class II	0.006	0	0.031	0.023	0.056	0.046	ns
SSTL18_I	SSTL_18 class I	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
SSTL18_II	SSTL_18 class II	-0.013	-0.015	0.015	0.007	0.042	0.029	ns
SSTL18D_I	Differential SSTL_18 class I	0.006	0.001	0.029	0.024	0.052	0.046	ns
SSTL18D_II	Differential SSTL_18 class II	0.006	0.001	0.029	0.024	0.052	0.046	ns
LVTTTL33	LVTTTL	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
LVC MOS33	LVC MOS 3.3	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
LVC MOS25	LVC MOS 2.5	0	0	0	0	0	0	ns
LVC MOS18	LVC MOS 1.8	-0.068	-0.068	-0.087	-0.087	-0.105	-0.105	ns
LVC MOS15	LVC MOS 1.5	-0.131	-0.131	-0.186	-0.186	-0.241	-0.241	ns
LVC MOS12	LVC MOS 1.2	-0.238	-0.238	-0.364	-0.364	-0.49	-0.49	ns
PCI33	PCI	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
PCIX33	PCI-X 3.3	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
PCIX15	PCI-X 1.5	-0.005	-0.016	0.026	-0.001	0.057	0.014	ns
AGP1X33	AGP-1X 3.3	0.034	0.034	-0.05	-0.05	-0.134	-0.134	ns
AGP2X33	AGP-2X	-0.036	-0.061	-0.181	-0.313	-0.326	-0.565	ns

LatticeSC/M Family Timing Adders (Continued)

Over Recommended Operating Conditions at VCC = 1.2V +/- 5%

Buffer Type	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
LVC MOS18_12mA	LVC MOS 1.8 12mA drive	0.024	-0.106	0.019	-0.004	0.016	0.099	ns
LVC MOS18_16mA	LVC MOS 1.8 16mA drive	0.074	-0.134	0.08	-0.022	0.088	0.089	ns
LVC MOS18_OD	LVC MOS 1.8 open drain	0.002	-0.206	0	-0.196	-0.002	-0.221	ns
LVC MOS15_4mA	LVC MOS 1.5 4mA drive	-0.344	-0.164	-0.379	-0.186	-0.412	-0.209	ns
LVC MOS15_8mA	LVC MOS 1.5 8mA drive	-0.125	-0.137	-0.145	-0.157	-0.164	-0.176	ns
LVC MOS15_12mA	LVC MOS 1.5 12mA drive	-0.027	-0.166	-0.043	-0.07	-0.059	0.026	ns
LVC MOS15_16mA	LVC MOS 1.5 16mA drive	0.025	-0.195	0.013	-0.089	0.003	0.017	ns
LVC MOS15_OD	LVC MOS 1.5 open drain	-0.047	-0.267	-0.067	-0.267	-0.087	-0.299	ns
LVC MOS12_2mA	LVC MOS 1.2 2mA drive	-0.473	-0.293	-0.505	-0.317	-0.537	-0.34	ns
LVC MOS12_4mA	LVC MOS 1.2 4mA drive	-0.218	-0.239	-0.25	-0.271	-0.28	-0.303	ns
LVC MOS12_8mA	LVC MOS 1.2 8mA drive	-0.109	-0.269	-0.143	-0.181	-0.176	-0.093	ns
LVC MOS12_12mA	LVC MOS 1.2 12mA drive	-0.054	-0.3	-0.085	-0.203	-0.114	-0.106	ns
LVC MOS12_OD	LVC MOS 1.2 open drain	-0.126	-0.371	-0.166	-0.398	-0.204	-0.43	ns
PCI33	PCI	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns
PCIX33	PCI-X 3.3	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns
PCIX15	PCI-X 1.5	0.208	0.227	0.233	0.312	0.259	0.398	ns
AGP1X33	AGP-1X 3.3	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns
AGP2X33	AGP-2X	-0.216	-0.791	-0.417	-1.263	-0.618	-1.735	ns

LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI_CLK_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

Switching Test Conditions

Figure 3-15 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-4.

Figure 3-15. Output Test Load, LVTTTL and LVCMOS Standards

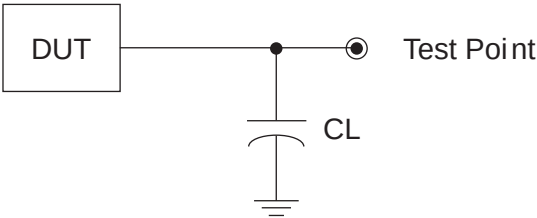


Table 3-4. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	C _L	Timing Ref.	V _T
LVTTTL and other LVCMOS settings (L -> H, H -> L)	30pF	LVCMOS 3.3 = 1.5V	—
		LVCMOS 2.5 = V _{CCIO} /2	—
		LVCMOS 1.8 = V _{CCIO} /2	—
		LVCMOS 1.5 = V _{CCIO} /2	—
		LVCMOS 1.2 = V _{CCIO} /2	—
LVCMOS 2.5 I/O (Z -> H)	30pF	V _{CCIO} /2	V _{OL}
LVCMOS 2.5 I/O (Z -> L)		V _{CCIO} /2	V _{OH}
LVCMOS 2.5 I/O (H -> Z)		V _{OH} - 0.15	V _{OL}
LVCMOS 2.5 I/O (L -> Z)		V _{OL} + 0.15	V _{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF4	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AE5	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AG3	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AH2	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AD6	PB4C	5		PB4C	5	
AJ2	PB5A	5		PB5A	5	
AK2	PB5B	5		PB5B	5	
AD7	PB5C	5		PB5C	5	
AD8	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AH3	PB7A	5		PB11A	5	
AJ3	PB7B	5		PB11B	5	
AF9	PB7C	5		PB11C	5	
AE10	PB7D	5		PB11D	5	
AK3	PB8A	5		PB12A	5	
AJ4	PB8B	5		PB12B	5	
AE11	PB9A	5		PB13A	5	
AF10	PB9B	5		PB13B	5	
AK4	PB11A	5		PB16A	5	
AK5	PB11B	5		PB16B	5	
AH10	PB12A	5	PCLKT5_3	PB20A	5	PCLKT5_3
AH11	PB12B	5	PCLKC5_3	PB20B	5	PCLKC5_3
AF13	PB12C	5	PCLKT5_4	PB20C	5	PCLKT5_4
AE14	PB12D	5	PCLKC5_4	PB20D	5	PCLKC5_4
AK6	PB13A	5	PCLKT5_5	PB21A	5	PCLKT5_5
AK7	PB13B	5	PCLKC5_5	PB21B	5	PCLKC5_5
AF14	PB13C	5		PB21C	5	
AJ11	PB15A	5	PCLKT5_0	PB23A	5	PCLKT5_0
AJ12	PB15B	5	PCLKC5_0	PB23B	5	PCLKC5_0
AH13	PB15D	5	VREF2_5	PB23D	5	VREF2_5
AK8	PB16A	5	PCLKT5_1	PB24A	5	PCLKT5_1
AK9	PB16B	5	PCLKC5_1	PB24B	5	PCLKC5_1
AH14	PB17A	5	PCLKT5_2	PB25A	5	PCLKT5_2
AG14	PB17B	5	PCLKC5_2	PB25B	5	PCLKC5_2
AK10	PB19A	5		PB28A	5	
AK11	PB19B	5		PB28B	5	
AH15	PB20A	5		PB29A	5	
AG15	PB20B	5		PB29B	5	
AH12	PB21A	5		PB31A	5	
AJ13	PB21B	5		PB31B	5	
AD15	PB21C	5		PB31C	5	
AE15	PB21D	5		PB31D	5	
AK12	PB23A	5		PB32A	5	
AK13	PB23B	5		PB32B	5	
AJ14	PB24A	5		PB33A	5	
AJ15	PB24B	5		PB33B	5	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P22	VCCIO2	-		VCCIO2	-	
R22	VCCIO2	-		VCCIO2	-	
AA23	VCCIO3	-		VCCIO3	-	
AA24	VCCIO3	-		VCCIO3	-	
AB23	VCCIO3	-		VCCIO3	-	
AB24	VCCIO3	-		VCCIO3	-	
T22	VCCIO3	-		VCCIO3	-	
U22	VCCIO3	-		VCCIO3	-	
V22	VCCIO3	-		VCCIO3	-	
W22	VCCIO3	-		VCCIO3	-	
Y22	VCCIO3	-		VCCIO3	-	
Y23	VCCIO3	-		VCCIO3	-	
Y24	VCCIO3	-		VCCIO3	-	
AB16	VCCIO4	-		VCCIO4	-	
AB17	VCCIO4	-		VCCIO4	-	
AB18	VCCIO4	-		VCCIO4	-	
AB19	VCCIO4	-		VCCIO4	-	
AB20	VCCIO4	-		VCCIO4	-	
AC20	VCCIO4	-		VCCIO4	-	
AC21	VCCIO4	-		VCCIO4	-	
AC22	VCCIO4	-		VCCIO4	-	
AD20	VCCIO4	-		VCCIO4	-	
AD21	VCCIO4	-		VCCIO4	-	
AD22	VCCIO4	-		VCCIO4	-	
AB11	VCCIO5	-		VCCIO5	-	
AB12	VCCIO5	-		VCCIO5	-	
AB13	VCCIO5	-		VCCIO5	-	
AB14	VCCIO5	-		VCCIO5	-	
AB15	VCCIO5	-		VCCIO5	-	
AC10	VCCIO5	-		VCCIO5	-	
AC11	VCCIO5	-		VCCIO5	-	
AC9	VCCIO5	-		VCCIO5	-	
AD10	VCCIO5	-		VCCIO5	-	
AD11	VCCIO5	-		VCCIO5	-	
AD9	VCCIO5	-		VCCIO5	-	
AA7	VCCIO6	-		VCCIO6	-	
AA8	VCCIO6	-		VCCIO6	-	
AB7	VCCIO6	-		VCCIO6	-	
AB8	VCCIO6	-		VCCIO6	-	
T9	VCCIO6	-		VCCIO6	-	
U9	VCCIO6	-		VCCIO6	-	
V9	VCCIO6	-		VCCIO6	-	
W9	VCCIO6	-		VCCIO6	-	
Y7	VCCIO6	-		VCCIO6	-	
Y8	VCCIO6	-		VCCIO6	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AJ1	PB69A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB85A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AK1	PB69B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB85B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AJ2	PB69C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB85C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AH3	PB69D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB85D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AH1	PROBE_VCC	-		PROBE_VCC	-	
AH2	PROBE_GND	-		PROBE_GND	-	
AD9	PR57D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR71D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AC10	PR57C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR71C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AG2	PR57B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR71B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AG1	PR57A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR71A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AD8	PR56D	3		PR70D	3	
AC9	PR56C	3		PR70C	3	
AF2	PR56B	3		PR70B	3	
AF1	PR56A	3		PR70A	3	
AE6	PR55D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR69D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AE7	PR55C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR69C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AE1	PR55B	3		PR69B	3	
AE2	PR55A	3		PR69A	3	
AB8	PR53D	3		PR67D	3	
AC8	PR53C	3		PR67C	3	
AE4	PR53B	3		PR67B	3	
AE3	PR53A	3		PR67A	3	
AA10	PR52D	3		PR66D	3	
AA9	PR52C	3		PR66C	3	
AD1	PR52B	3		PR66B	3	
AC1	PR52A	3		PR66A	3	
AC7	PR51D	3	VREF2_3	PR65D	3	VREF2_3
AB7	PR51C	3		PR65C	3	
AD5	PR51B	3		PR65B	3	
AC5	PR51A	3		PR65A	3	
AE5	PR49D	3		PR62D	3	
AF5	PR49C	3		PR62C	3	
AD3	PR49B	3		PR62B	3	
AD4	PR49A	3		PR62A	3	
Y10	PR48D	3		PR61D	3	
Y9	PR48C	3		PR61C	3	
AC2	PR48B	3		PR61B	3	
AD2	PR48A	3		PR61A	3	
AC6	PR47D	3		PR60D	3	
AB6	PR47C	3		PR60C	3	
AA1	PR47B	3		PR60B	3	
AB1	PR47A	3		PR60A	3	
AA5	PR44D	3		PR53D	3	
AB5	PR44C	3		PR53C	3	
Y1	PR44B	3		PR53B	3	
W1	PR44A	3		PR53A	3	
W8	PR43D	3		PR52D	3	
Y7	PR43C	3		PR52C	3	
Y5	PR43B	3		PR52B	3	
W5	PR43A	3		PR52A	3	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH11	PB57D	4		PB79D	4	
AN13	PB58A	4	PCLKT4_3	PB80A	4	PCLKT4_3
AN12	PB58B	4	PCLKC4_3	PB80B	4	PCLKC4_3
AD14	PB58C	4	PCLKT4_4	PB80C	4	PCLKT4_4
AD15	PB58D	4	PCLKC4_4	PB80D	4	PCLKC4_4
AP13	PB61A	4		PB73A	4	
AP12	PB61B	4		PB73B	4	
AK13	PB61C	4		PB73C	4	
AK12	PB61D	4		PB73D	4	
AP11	PB62A	4		PB83A	4	
AP10	PB62B	4		PB83B	4	
AN11	PB63A	4		PB99A	4	
AN10	PB63B	4		PB99B	4	
AF14	PB63C	4		PB99C	4	
AF13	PB63D	4		PB99D	4	
AM10	PB67A	4		PB101A	4	
AM9	PB67B	4		PB101B	4	
AE14	PB67C	4		PB101C	4	
AE13	PB67D	4		PB101D	4	
AP9	PB69A	4		PB104A	4	
AP8	PB69B	4		PB104B	4	
AK11	PB69C	4		PB104C	4	
AK10	PB69D	4		PB104D	4	
AL10	PB70A	4		PB107A	4	
AL9	PB70B	4		PB107B	4	
AF12	PB70C	4		PB107C	4	
AF11	PB70D	4		PB107D	4	
AN9	PB73A	4		PB109A	4	
AN8	PB73B	4		PB109B	4	
AG11	PB73C	4		PB109C	4	
AG10	PB73D	4		PB109D	4	
AP7	PB74A	4		PB111A	4	
AP6	PB74B	4		PB111B	4	
AG13	PB74C	4		PB111C	4	
AG12	PB74D	4		PB111D	4	
AN7	PB75A	4		PB113A	4	
AN6	PB75B	4		PB113B	4	
AK9	PB75C	4		PB113C	4	
AK8	PB75D	4		PB113D	4	
AP5	PB77A	4		PB115A	4	
AP4	PB77B	4		PB115B	4	
AD11	PB77C	4		PB115C	4	
AE11	PB77D	4		PB115D	4	
AM7	PB78A	4		PB117A	4	
AM6	PB78B	4		PB117B	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AL23	PB56D	5		PB58D	5	
AW24	PB57A	5		PB61A	5	
AW23	PB57B	5		PB61B	5	
AN23	PB57C	5		PB61C	5	
AP23	PB57D	5		PB61D	5	
AY23	PB59A	5		PB63A	5	
AY24	PB59B	5		PB63B	5	
AU23	PB59C	5		PB63C	5	
AU22	PB59D	5		PB63D	5	
AV23	PB60A	5		PB66A	5	
AV22	PB60B	5		PB66B	5	
AM22	PB60C	5		PB66C	5	
AL22	PB60D	5		PB66D	5	
BA23	PB61A	5		PB69A	5	
BA22	PB61B	5		PB69B	5	
AN22	PB61C	5		PB69C	5	
AP22	PB61D	5		PB69D	5	
BB23	PB63A	5		PB71A	5	
BB22	PB63B	5		PB71B	5	
AT22	PB63C	5		PB71C	5	
AR22	PB63D	5		PB71D	5	
BB21	PB65A	4		PB73A	4	
BB20	PB65B	4		PB73B	4	
AR21	PB65C	4		PB73C	4	
AT21	PB65D	4		PB73D	4	
BA21	PB66A	4		PB75A	4	
BA20	PB66B	4		PB75B	4	
AP21	PB66C	4		PB75C	4	
AN21	PB66D	4		PB75D	4	
AV21	PB67A	4		PB78A	4	
AV20	PB67B	4		PB78B	4	
AM21	PB67C	4		PB78C	4	
AL21	PB67D	4		PB78D	4	
AY20	PB69A	4		PB81A	4	
AY19	PB69B	4		PB81B	4	
AU21	PB69C	4		PB81C	4	
AU20	PB69D	4		PB81D	4	
AW20	PB70A	4		PB83A	4	
AW19	PB70B	4		PB83B	4	
AP20	PB70C	4		PB83C	4	
AN20	PB70D	4		PB83D	4	
BB19	PB71A	4		PB86A	4	
BB18	PB71B	4		PB86B	4	
AM20	PB71C	4		PB86C	4	
AL20	PB71D	4		PB86D	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V8	PR41C	2		PR55C	2	
T4	PR41B	2		PR55B	2	
U4	PR41A	2		PR55A	2	
V9	PR39D	2		PR53D	2	
U9	PR39C	2		PR53C	2	
V6	PR39B	2		PR53B	2	
U6	PR39A	2		PR53A	2	
AA12	PR38D	2		PR52D	2	
Y12	PR38C	2		PR52C	2	
P1	PR38B	2		PR52B	2	
N1	PR38A	2		PR52A	2	
T7	PR37D	2		PR51D	2	
R7	PR37C	2		PR51C	2	
T5	PR37B	2		PR51B	2	
R5	PR37A	2		PR51A	2	
U10	PR35D	2		PR49D	2	
V10	PR35C	2		PR49C	2	
P2	PR35B	2		PR49B	2	
N2	PR35A	2		PR49A	2	
T8	PR34D	2		PR48D	2	
R8	PR34C	2		PR48C	2	
N3	PR34B	2		PR48B	2	
P3	PR34A	2		PR48A	2	
M6	PR33D	2		PR47D	2	
M7	PR33C	2		PR47C	2	
T6	PR33B	2		PR47B	2	
R6	PR33A	2		PR47A	2	
V11	PR31D	2		PR45D	2	
U11	PR31C	2		PR45C	2	
M1	PR31B	2		PR45B	2	
L1	PR31A	2		PR45A	2	
Y14	PR30D	2		PR44D	2	
W14	PR30C	2		PR44C	2	
M2	PR30B	2		PR44B	2	
L2	PR30A	2		PR44A	2	
T9	PR29D	2	DIFFR_2	PR43D	2	DIFFR_2
R9	PR29C	2	VREF1_2	PR43C	2	VREF1_2
P4	PR29B	2		PR43B	2	
N4	PR29A	2		PR43A	2	
N7	PR26D	2		PR40D	2	
N8	PR26C	2		PR40C	2	
P5	PR26B	2		PR40B	2	
N5	PR26A	2		PR40A	2	
K7	PR25D	2		PR38D	2	
J7	PR25C	2		PR38C	2	

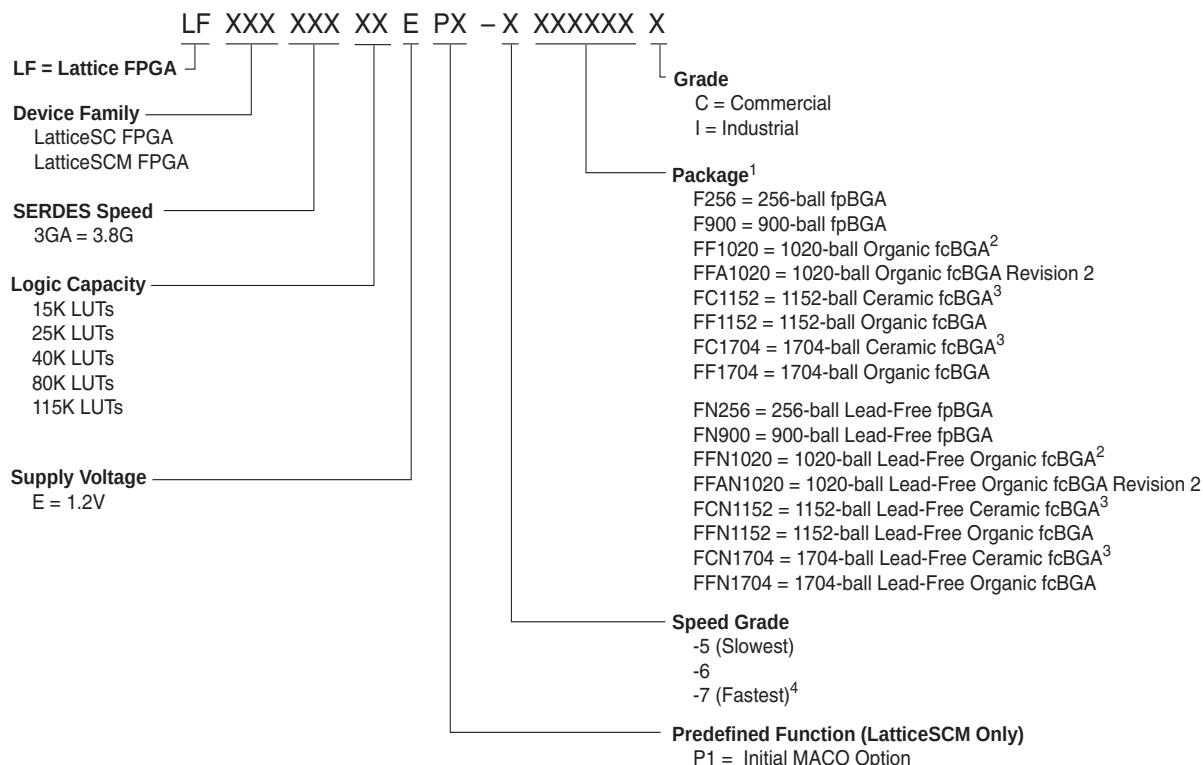
LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D1	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
F1	VCC12	-		VCC12	-	
A3	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
E1	A_VDDOB0_R	-		A_VDDOB0_R	-	
B3	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
C2	A_VDDOB1_R	-		A_VDDOB1_R	-	
A4	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
B2	VCC12	-		VCC12	-	
B4	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
E3	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
D3	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
M10	VCC12	-		VCC12	-	
E2	A_VDDIB1_R	-		A_VDDIB1_R	-	
J11	VCC12	-		VCC12	-	
M11	A_VDDIB2_R	-		A_VDDIB2_R	-	
D4	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
E4	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
K9	VCC12	-		VCC12	-	
A5	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
D2	A_VDDOB2_R	-		A_VDDOB2_R	-	
B5	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
L10	A_VDDOB3_R	-		A_VDDOB3_R	-	
B6	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
G6	VCC12	-		VCC12	-	
A6	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
E5	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
D5	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
K12	VCC12	-		VCC12	-	
L13	A_VDDIB3_R	-		A_VDDIB3_R	-	
N14	VCC12	-		VCC12	-	
F9	B_VDDIB0_R	-		B_VDDIB0_R	-	
D6	B_HDINP0_R	-	PCS 3E1 CH 0 IN P	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
E6	B_HDINN0_R	-	PCS 3E1 CH 0 IN N	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
J8	VCC12	-		VCC12	-	
B7	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
G4	B_VDDOB0_R	-		B_VDDOB0_R	-	
A7	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
K8	B_VDDOB1_R	-		B_VDDOB1_R	-	
A8	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L9	VCC12	-		VCC12	-	
B8	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
E7	B_HDINN1_R	-	PCS 3E1 CH 1 IN N	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
D7	B_HDINP1_R	-	PCS 3E1 CH 1 IN P	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
F10	VCC12	-		VCC12	-	
K13	B_VDDIB1_R	-		B_VDDIB1_R	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
A26	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N
C34	D_VDDOB2_L	-		D_VDDOB2_L	-	
B26	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P
C32	VCC12	-		VCC12	-	
E27	D_HDINN2_L	-	PCS 363 CH 2 IN N	D_HDINN2_L	-	PCS 363 CH 2 IN N
D27	D_HDINP2_L	-	PCS 363 CH 2 IN P	D_HDINP2_L	-	PCS 363 CH 2 IN P
G25	D_VDDIB2_L	-		D_VDDIB2_L	-	
F29	VCC12	-		VCC12	-	
H26	D_VDDIB1_L	-		D_VDDIB1_L	-	
F30	VCC12	-		VCC12	-	
D28	D_HDINP1_L	-	PCS 363 CH 1 IN P	D_HDINP1_L	-	PCS 363 CH 1 IN P
E28	D_HDINN1_L	-	PCS 363 CH 1 IN N	D_HDINN1_L	-	PCS 363 CH 1 IN N
B27	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P
F36	VCC12	-		VCC12	-	
A27	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N
F35	D_VDDOB1_L	-		D_VDDOB1_L	-	
A28	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N
M30	D_VDDOB0_L	-		D_VDDOB0_L	-	
B28	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P
F37	VCC12	-		VCC12	-	
E29	D_HDINN0_L	-	PCS 363 CH 0 IN N	D_HDINN0_L	-	PCS 363 CH 0 IN N
D29	D_HDINP0_L	-	PCS 363 CH 0 IN P	D_HDINP0_L	-	PCS 363 CH 0 IN P
H27	D_VDDIB0_L	-		D_VDDIB0_L	-	
G28	VCC12	-		VCC12	-	
J28	C_REFCLKP_L	-		C_REFCLKP_L	-	
K28	C_REFCLKN_L	-		C_REFCLKN_L	-	
F32	VCC12	-		VCC12	-	
G29	C_VDDIB3_L	-		C_VDDIB3_L	-	
C31	VCC12	-		VCC12	-	
D30	C_HDINP3_L	-	PCS 362 CH 3 IN P	C_HDINP3_L	-	PCS 362 CH 3 IN P
E30	C_HDINN3_L	-	PCS 362 CH 3 IN N	C_HDINN3_L	-	PCS 362 CH 3 IN N
B29	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P
F38	VCC12	-		VCC12	-	
A29	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N
J33	C_VDDOB3_L	-		C_VDDOB3_L	-	
A30	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N
K33	C_VDDOB2_L	-		C_VDDOB2_L	-	
B30	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P
J34	VCC12	-		VCC12	-	
F31	C_HDINN2_L	-	PCS 362 CH 2 IN N	C_HDINN2_L	-	PCS 362 CH 2 IN N
E31	C_HDINP2_L	-	PCS 362 CH 2 IN P	C_HDINP2_L	-	PCS 362 CH 2 IN P
G30	C_VDDIB2_L	-		C_VDDIB2_L	-	
H28	VCC12	-		VCC12	-	
C37	C_VDDIB1_L	-		C_VDDIB1_L	-	
H30	VCC12	-		VCC12	-	

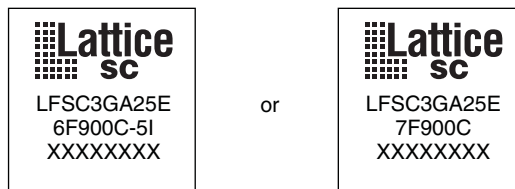
Part Number Description



1. fpBGA = 1.0 mm pitch BGA, fcBGA = 1.0 mm flip-chip BGA (organic and ceramic).
2. Converted to organic fcBGA per PCN #02A-10.
3. Converted to organic fcBGA per PCN #01A-10.
4. Not available in the LatticeSC115 and LatticeSCM115 devices.

Ordering Information

Depending on the speed and temperature grade, the device can either be dual marked or single marked. The commercial grade is one speed grade faster than the associated dual marked industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



Temperature Grade	Speed Grade	Single or Dual Mark?
Commercial	-7	Either OK
	-6	Dual Only
	-5	Single Only
Industrial	-6	Either OK
	-5	Dual Only

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FCN1152I ¹	-6	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-5FCN1152I ¹	-5	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	115.2
LFSC3GA115E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	115.2
LFSC3GA115E-6FCN1704I ¹	-6	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-5FCN1704I ¹	-5	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	115.2
LFSC3GA115E-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FCN1152I ¹	-6	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FCN1152I ¹	-5	Lead-Free Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FCN1704I ¹	-6	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FCN1704I ¹	-5	Lead-Free Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-6FFN1704I	-6	Lead-Free Organic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FFN1704I	-5	Lead-Free Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).